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## ***PCI Express for the 7 Series FPGAs***

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Since the introduction of the PCI Express® protocol, Xilinx has been the market leader in FPGA-based PCI Express solutions—from the soft IP FPGA logic-based solutions in the Virtex®-II Pro family, to the first Integrated Block for PCI Express in the Virtex-5 FPGA family, to its continued use in Virtex-6 and Spartan®-6 devices. The Xilinx® 7 series FPGAs include the latest generation Integrated Block for PCI Express within a Xilinx FPGA, including support for PCI Express 3.0 at 8.0 Gb/s data rates. This breadth of experience has provided Xilinx the expertise to develop the easiest to use, most feature-rich, and highest performance PCI Express solution available.

# PCI Express Specification Evolution

PCI Express specifications are constantly evolving. Since its introduction by the PCI Special Interest Group (PCI-SIG) in 2003, the *PCI Express Base Specification* has undergone two major revisions and three minor revisions. The current version, v3.0, commonly called Gen 3, was released in November 2010. Gen 3 doubles the maximum theoretical bandwidth of PCI Express by increasing the line rate from 5.0 Gb/s to 8.0 Gb/s and by using a 128B/130B encoding scheme. This more efficient encoding scheme incurs only a 1.5% overhead penalty as opposed to the 20% penalty incurred with 8B/10B. It also incorporates many of the engineering change notices from the previous PCIe revision to optimize efficiency, reduce system latency, improve performance, and lower power consumption.

[Table 1](#) summarizes the evolution of the *PCI Express Base Specification*.

**Table 1: PCI Express Base Specification Details**

PCI Specification	Line Rate	Encoding Scheme and Added Overhead	Maximum Theoretical Bandwidth <sup>(1)</sup>
Gen 1	2.5 Gb/s	8B/10B = 20%	2.0 Gb/s
Gen 2	5.0 Gb/s	8B/10B = 20%	4.0 Gb/s
Gen 3	8.0 Gb/s	128B/130B = 1.5%	7.88 Gb/s

**Notes:**

1. Achievable system bandwidth is less than effective bandwidth due to packet overhead, traffic overhead, and other system inefficiencies.

In addition to revising the base specification, the PCI-SIG also promotes companion specifications that support specific applications. One companion specification that is being rapidly adopted is I/O Virtualization, particularly [Single Root I/O Virtualization](#) (SR-IOV). SR-IOV greatly improves I/O utilization in a shared and virtualized environment. This feature is supported in 7 series FPGAs.

## 7 Series FPGAs PCI Express Overview

Every Xilinx 7 series FPGA family supports the Integrated Root Port and Endpoint for PCI Express solution. Artix™-7 devices support up to Gen2x4 configurations. Kintex™-7 and Virtex-7 T devices support up to Gen2x8 configurations. The Virtex-7 XT and HT devices feature an integrated Gen 3 core, up to 8 lanes.

In addition to the Integrated Block for PCI Express, third party Alliance partners Northwest Logic and PLDA provide Gen3x8 soft IP solutions that target both Kintex-7 and Virtex-7 families.

[Table 2](#) summarizes the level of support for each family.

**Table 2: Lane Width and Speed Support**

Family	Hard IP	Soft IP
Artix-7	Gen2x4	—
Kintex-7	Gen2x8	Gen3x8
Virtex-7 T	Gen2x8	Gen3x8
Virtex-7 HT	Gen3x8	—
Virtex-7 XT	Gen3x8	—

The scalable, optimized architecture of the blocks, along with the AXI4 user interfaces, allow easy migration and design reuse across all 7 series devices, from low-cost to ultra high-performance applications.

The Integrated Block for 7 series FPGAs can be configured using simple GUI-based tool flows to create Endpoint, Root Port, or Root Complex solutions. Endpoint and Root Port solutions can be easily created using the CORE Generator™ tool, while a Root Complex solution can be built using the Xilinx Platform Studio for embedded processing development. These tools give the system designer control over many configurable parameters such as lane width, line rate, maximum payload size, FPGA logic interface speeds, reference clock frequency, and base address register settings.

In addition to easy-to-use development and implementation tools, Xilinx provides Targeted Reference Designs—fully validated and supported application examples—that accelerate the design schedule. These Targeted Reference Designs include all components of PCI Express design, such as DMA controllers, custom-IP, device drivers, and software applications.

To learn more about Targeted Reference Designs for PCI Express, see:

<http://www.xilinx.com/technology/connectivity.htm>

## PCI Express Gen 3 Integrated Block for Virtex XT and HT Devices

Virtex-7 XT and HT devices support multiple integrated Gen 3 integrated blocks, up to eight lanes each. This integrated block is capable of operating at the prescribed data rate of 8.0 Gb/s per lane using 128B/130B encoding. Table 3 shows the 7 series devices that have Gen 3 capable integrated blocks, and the number of blocks per devices.

**Table 3: 7 Series Devices with Gen 3 Capable Hard Blocks**

Device	Number of PCIe Gen 3 Capable Integrated Blocks
XC7VX330T	2
XC7VX415T	2
XC7VX550T	3
XC7VX690T	3
XC7VX980T	3
XC7VX1140T	4
XC7VH290T	1
XC7VH580T	2
XC7VH870T	3

### PCIe Gen 3 Transceiver Advantage in 7 Series

The GTH transceivers contain features that allow for very robust operation at PCIe Gen 3 data rates. These features include:

- Transmitter Emphasis/equalization
- Auto-adaptive Continuous-time Linear Equalizer (CTLE)
- Auto-adaptive Decision Feedback Equalizer (DFE)

The transmitter emphasis circuit is designed to overcome high frequency channel insertion loss and is implemented as a 3-tap FIR filter. The 3 taps consist of a pre, main, and post cursor taps. These taps are programmable and can support all of the various PCIe Gen 3 Preset settings as well as link-partner specified tap settings. Typically, the user does not need to explicitly set the taps values because this is handled automatically by the PCIe Gen 3 Link Equalization protocol.

The CTLE and DFE circuits in the GTH transceivers work together to compensate for up to 20 dB of loss. The CTLE employs a fully auto-adaptive algorithm that continuously monitors the incoming signal, and optimally adjusts the frequency response of the high-pass filter function. This auto-adaptive feature lessens the burden on the user and solves the issue of over-equalization or under-equalization.

The DFE is implemented with seven fixed-taps and four independent sliding taps. The sliding taps can compensate for channel reflections occurring up to 63 UI away from the main cursor. This is extremely useful when PCIe is used over a backplane, as commonly found in many wired communication and datacenter applications. Similar to the CTLE, the DFE is also completely auto-adaptive for both tap values, and location of sliding taps.

For a detailed description on some of the advanced equalization features offered by the 7 series transceivers, please see white paper [WP419](#), *Equalization for High-Speed Serial Interfaces in Xilinx 7 Series FPGA Transceivers*.

## PCI Express Gen 3 Data Throughput

The PCI-SIG sets a goal of doubling the effective data throughput for each new generation of PCI Express, and Gen 3 is no exception. It is important to note that effective data throughput (sometimes referred to as effective data transfer rate) is not the same thing as raw data transfer rate, such as 8 Gb/s line rate. The effective data throughput rate is dependent on many variables, such as:

- Lane width
- Line rate
- System Maximum Payload Size and Maximum Read Request Size
- TLP overhead
- Link management (Data link layer packets)
- Encoding loss
- DMA scatter-gather overhead

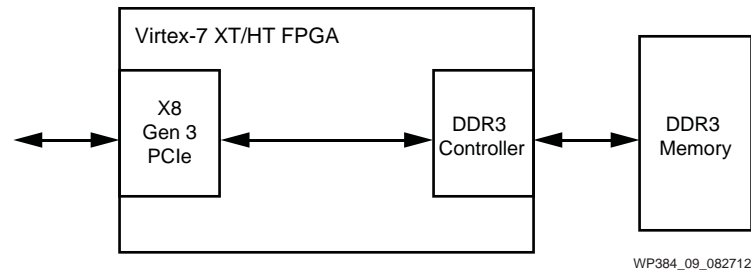
For a discussion on all of the possible variables for effective data throughput, see [WP350](#), *Understanding Performance of PCI Express Systems*.

The 7 Series Gen 3 Integrated Block for PCI Express is capable of sustained throughput of over 7 GB/s per direction, when configured as an x8 Gen 3 capable core operating in a real system with a 256 byte system Maximum Payload Size. A video demonstration of this performance can be found on the [PCI Express](#) landing page.

The design shown in the video demonstration is a throughput test application that shows maximum possible throughput for the PCIe Gen 3 core on a given system. When a real scatter-gather DMA is used instead, the effective data throughput will likely drop. A very reasonable effective data throughput that users can expect with a scatter-gather DMA is around 6.5 GB/s per direction.

## Interfacing to Memory

Most PCIe applications use some type of memory for data buffering, typically DDR SDRAM. The 6.5 GB/s throughput example given for the scatter-gather DMA is actually a good fit for Xilinx DDR3 memory solutions. See [Figure 1](#).



*Figure 1: Interfacing DDR3 Memory to Virtex-7 XT/HT FPGAs*

When determining memory bandwidth requirements, the designer should use a 2.5X bandwidth multiplier factor to account for both read and write directions and any additional overhead such as memory addressing.

For example, if transferring sustained 6.5 GB/s from the PCIe link and all of this data is buffered in DDR3 memory, the designer can calculate the following to determine the memory bandwidth and/or interface width requirements.

### Determining Memory Bandwidth Requirements

Total Memory Bandwidth Required for Sustained Transfers:

$$6.5 \text{ GB/s} * 2.5 = 16.25 \text{ GB/s}$$

Example: If using an 1,866 Mb/s DDR3 capable memory, the designer can calculate how wide the data interface has to be to keep up with 16.25 GB/s.

Convert to Gb/s:

$$16.25 \text{ GB/s} * 8 \text{ bits/byte} = 130 \text{ Gb/s}$$

Calculate Required Interface Width for DDR3 Memory:

$$130 \text{ Gb/s} / 1,866 \text{ Mb/s per pin} = \sim 70 \text{ pins}$$

This calculation shows that a standard 72-pin DDR3 interface operating at 1,866 Mb/s can keep up with full-duplex data from a x8 Gen 3 PCI Express link.

FPGAs that support slower DDR data rates, such as 1,600 Mb/s, require additional pins and components.

For more information on 7 series memory solutions, see [WP383](#), *Achieving High Performance DDR3 Data Rates in Virtex-7 and Kintex-7 FPGAs*.

## Additional High-Performance Features for the Gen 3 Integrated Block for PCI Express

The Gen 3 Integrated Block for PCIe contains many features that enable better system performance. These features include:

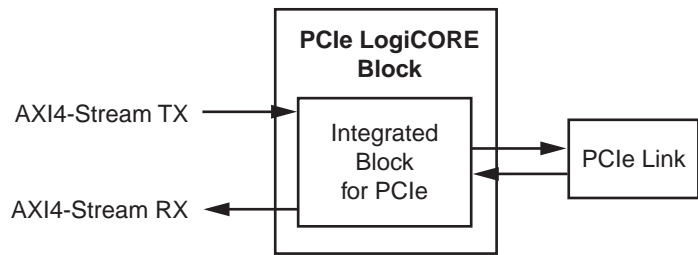
- High-performance, dedicated AXI4 interfaces for traffic type (enhanced AXI-4 stream)
- Data straddling on the 256-bit width interface
- Built in tag management for up to 64 outstanding read requests
- Flexible receive buffering; configurable up to 8 KB Request and 16 KB completion spaces
- Built-in multi-function and SR-IOV support
- Parity protection on AXI4 interfaces
- ECC protection on all internal buffer memory
- Resizable Base Address Registers (RBAR)
- Address Translation Services (ATS)
- Atomic Operation Transactions
- TLP Processing Hints Capability (TPH)
- Optimized Buffer Flush/Fill Capability (OBFF)
- Dynamic Power Allocation Capability (DPA)
- Power Budgeting capability (PB)

## Scalable, Optimized AXI Interface

Xilinx's deployment of the AMBA®4 AXI4 specification allows for a consistent way to connect IP blocks while enabling better use of design resources. AXI4 allows the use and reuse of IP and enables easier integration across IP providers, all in support of Plug-and-Play FPGA design. See [UG477](#), *7 Series FPGAs Integrated Block for PCI Express* and [PG023](#), *Virtex-7 FPGA Gen 3 Integrated Block for PCI Express*.

All PCI Express solutions for 7 series FPGAs are designed to the AMBA4 AXI4 specification. Three "flavors" of AXI interfaces are provided, each tailored for a different customer use case:

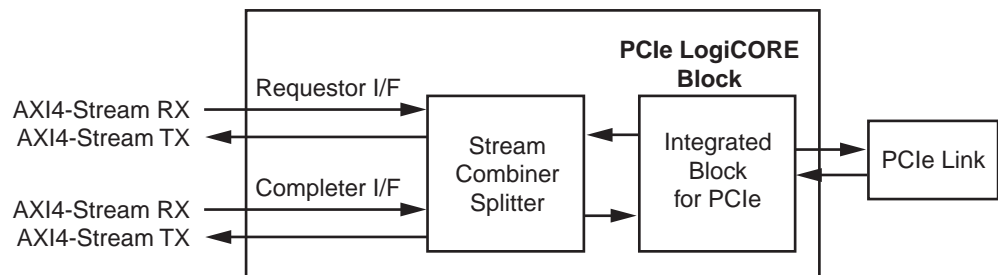
1. **Basic AXI4-Stream:** This interface is analogous to the legacy TRN interface found in older Xilinx FPGA families. This interface is the easiest with which to migrate TRN-based designs to 7 series devices and consists of transmit and receive AXI4-Stream interfaces. This interface is available for PCI Express solutions on Artix-7, Kintex-7, and Virtex-7 T FPGAs (not available on Virtex-7 XT devices). See [Figure 2](#).



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Figure 2: Basic AXI4-Stream Interface

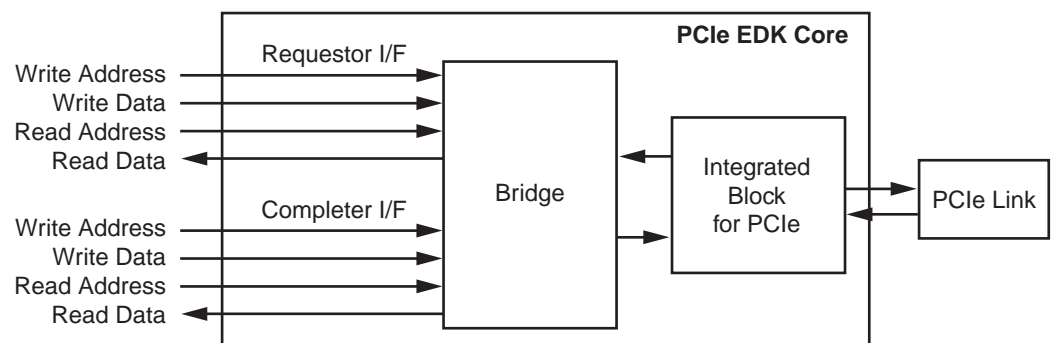
- Enhanced AXI4-Stream: This interface is similar to the basic AXI4-Stream interface but expands on it by splitting/combining the data stream into Completer and Requester streams. The enhanced version also allows for optional features such as packet destraddling, data realignment, and completion tag management. This interface is available on Virtex-7 HT and XT FPGAs (not available on Virtex-7 T, Artix-7, and Kintex-7 devices) for PCI Express solutions. See [Figure 3](#).



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Figure 3: Enhanced AXI4-Stream Interface

- AXI4: This is a memory-mapped interface for use with processor system-based cores. This interface is the migration path for embedded designs and is available on Artix-7, Kintex-7, and Virtex-7 T, HT, and XT FPGAs for PCI Express solutions. See [Figure 4](#).



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Figure 4: AXI4 Interface

## New PCI Express Features for 7 Series FPGAs

Many new features have been added to the 7 series PCI Express solutions to give designers the ultimate in PCI Express performance, flexibility, and ease of use.

### Fast Initialization for the Integrated Block for PCI Express

The *PCI Express Base Specification* requires the PCI Express link to be ready to link train within 100 ms after power is stable (see [UG477](#), *7 Series FPGAs Integrated Block for PCI Express User Guide*, for additional information). This has traditionally been a challenge for large FPGAs (>100,000 logic cells) because it can take well over 100 ms to configure a large FPGA using common flash memory devices.

“Brute force” methods are traditionally used to resolve the 100 ms requirement. Typically, designers use the fastest and widest flash memory devices available to achieve the necessary bandwidth to meet the configuration time requirement. Some cases require the use of multiple flash devices in conjunction with a CPLD to achieve the required bandwidth. While this can be the simplest method from a software perspective, it is often the most expensive due to increased BOM cost. This method also uses valuable FPGA I/O, especially when using wide input buses, and is quickly becoming obsolete as the size of Xilinx FPGAs has grown to two million logic cells and higher.

Beginning with the Virtex-6 family, Xilinx is the first FPGA company to provide multiple methods to meet this initialization requirement, each with different levels of complexity and expense.

**Note:** This issue is generally limited to Endpoint Add-in Card designs.

### Tandem PROM and Tandem PCIe

The Tandem PROM method is new in the 7 series devices and is the simplest and least expensive to implement. The user directs the implementation tools to create a two-stage bitstream via a simple software switch when building the PCI Express core. The first stage of the bitstream contains just the configuration frames necessary to configure the Integrated Block for PCI Express. When configured, an FPGA STARTUP sequence occurs, and the PCI Express link becomes active, thus easily satisfying the 100 ms requirement. The remainder of the FPGA configuration is then loaded while the PCI Express enumeration/configuration system process is occurring. The two-stage bitstream method can use an inexpensive flash device to hold the bitstream(s). See [Figure 5](#).

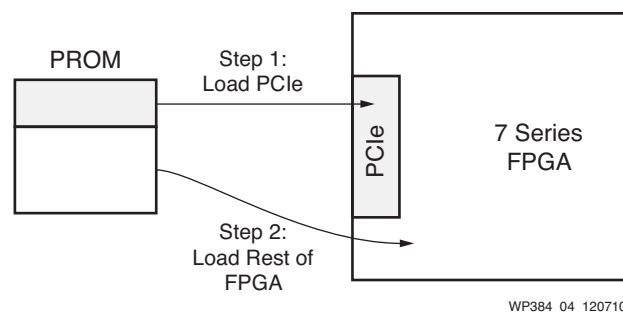


Figure 5: Tandem PROM Method

The Tandem PCIe solution builds off the Tandem PROM technology and allows the user to load the second-stage bitstream via the PCI Express link.



## Partial Reconfiguration

To implement multiple user applications that are connected via PCI Express, the partial reconfiguration tool flow can be used. This method relies on bitstream compression to meet the 100 ms requirement. The initial bitstream contains the PCI Express core with a connection to the Internal Configuration Access Port (ICAP). The majority of the FPGA is left unconfigured. The initial bitstream is then reduced in size by using bitstream compression, allowing fast initialization.

The partial bitstream for the unconfigured portion of the FPGA is downloaded on-the-fly via the PCI Express link. Using the partial reconfiguration tool flow, the designer creates one or multiple applications (partial bitstreams) that can reside in the host. Applications such as co-processing algorithm accelerators in the high-performance computing market benefit from such on-the-fly reprogrammability. This partial reconfiguration methodology, accompanied by an example reference design, is detailed in [XAPP883](#), *Fast Configuration of PCI Express Technology through Partial Reconfiguration*. XAPP883 provides a single partial bitstream example. The reference design can be extended by the user to support multiple partial bitstreams. See [Figure 6](#).

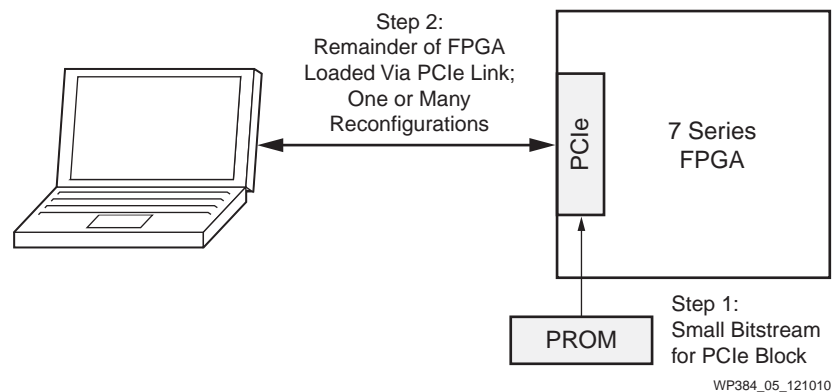


Figure 6: Partial Reconfiguration Tool Flow

## Data Straddling for Performance

Xilinx has made many enhancements to the Integrated Block for PCI Express in 7 series FPGAs to improve the performance of the core. The Integrated Block for PCI Express has the highest throughput performance for any FPGA-based PCI Express solution on the market. Most FPGA-based solutions require the Transaction Layer Packets (TLPs) on the user interface to be received in an aligned manner, that is, when a TLP ends. The next TLP cannot then be read from the core until the next clock cycle.

These solutions introduce gaps within the data stream, which in turn reduce overall data throughput. The 7 series FPGAs have the ability to straddle packets (allow one TLP to end while another begins on the same clock cycle) on the user interface, thereby allowing the PCI Express core to run at the full line rate. This is important for ultra high end applications that require full line rate bandwidth. For applications that do not require extreme bandwidth and prefer aligned packets, the enhanced AXI-Stream interface has an optional alignment feature. See [Figure 7](#).

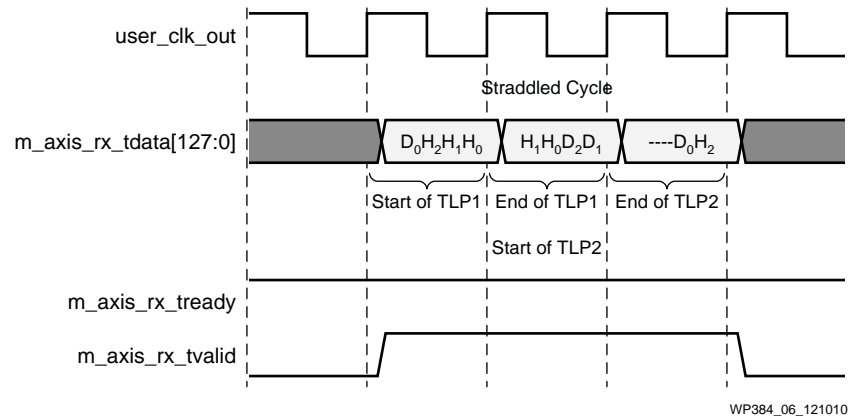


Figure 7: 7 Series Straddled Cycle

In addition to support for straddled packets, the 7 series FPGAs also have features to improve overall performance such as improved user control for credit allocation schemes as well as new flow control capabilities that give the user more granular control over Posted and Non-Posted traffic.

## Tag Management for Read Request Completions

One of the difficult tasks that a designer must undertake when transmitting Read Request TLPs that are larger than a typical system Read Completion Boundary size of 64 bytes is the handling of multiple completions and completions that are returned out-of-order. Typically, the designer must store the tags for outgoing read requests, and then reconcile and manage those tags with the incoming completion TLPs. In addition, the designer must also monitor for error conditions, such as completion time-outs.

Tag management is a necessary feature for Bus-Mastering DMA designs that send Read Requests, or in other words, “pull” data from a producer. This is done by managing the tags for outgoing read-requests and reconciling the incoming completions to these tags. The PCI Express solution for the Virtex-7 HT and XT devices optionally provides this tag management feature, greatly simplifying the design requirements for DMA designers.

## Multiple-Function

7 series FPGAs have the ability to operate as multiple-function devices. This type of device has several functions all sharing a single PCI Express link. Each function has its own PCI Express Configuration Header space; thus, from a host-system software perspective, each function appears as an individual PCI Express device on its own PCI Express link. This greatly simplifies device driver development and portability because the driver developer can create a single driver and replicate it for each hardware function. See [Figure 8](#).

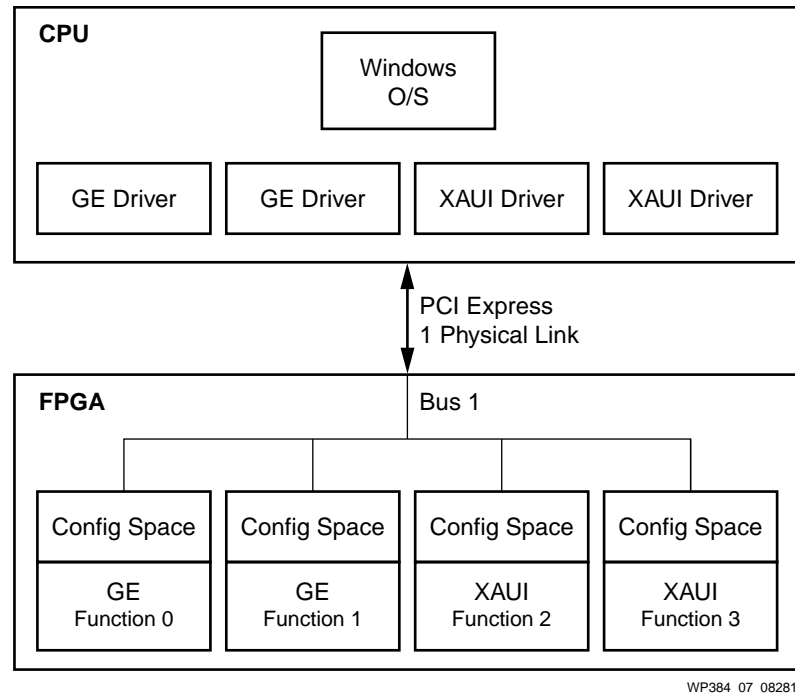


Figure 8: Multiple Function Devices

The Virtex-7 XT devices have a completely integrated solution, supporting up to two physical functions.

## Single Root I/O Virtualization

Single Root I/O Virtualization (SR-IOV) allows for multiple guests (operating systems) running on a single root (CPU subsystem) to access I/O devices without the software penalty incurred in virtualized systems that do not support SR-IOV. Similar to how multi-function devices provide an individual configuration space for each physical function, SR-IOV works by providing a virtual function (virtual configuration space) for each guest operating system accessing the I/O device. Thus, each guest operating system has its own "view" of the I/O device.

Adapters that support SR-IOV have shown vast improvements in I/O efficiency in virtualized environments. Not only has SR-IOV become a widely adopted standard within the Enterprise IT market (datacenter), but it is beginning to see inroads within the communications and storage networking markets as well. See [Figure 9](#).

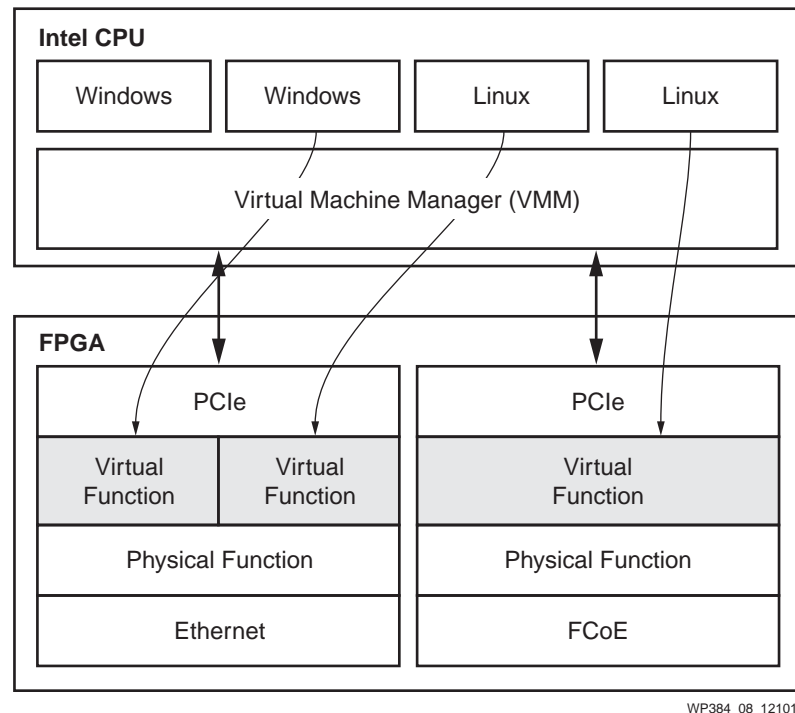


Figure 9: SR-IOV Virtual Configuration Space

The Virtex-7 HT and Virtex-7 XT and HT devices have a completely integrated solution, supporting up to two physical functions and six virtual functions.

## Advanced Error Reporting and End-to-End CRC

Advanced Error Reporting (AER) is an optional feature that provides more granularity and control for the types of errors that can occur in a PCI Express based system. In non-AER PCI Express based systems, only three types of errors are defined: fatal, non-fatal, and correctable. In most cases, the three defined error types do not give enough information to the system to recover gracefully from an error. With AER enabled, the system software can determine the exact cause of a particular error and attempt to recover if possible.

The Integrated Block for PCI Express in the 7 series FPGAs optionally performs automatic end-to-end CRC (ECRC) checking and generation, when enabled by the user. New ports have been added to control the error generation and flags if an ECRC error is detected. Designers no longer have to design this logic in the FPGA.

AER and ECRC are used in applications where high reliability and high availability are key driving factors. These features are commonly used in market segments like Aerospace and Defense, Banking and Finance, Communications, and Storage.

## Resizable BARs

Many endpoint applications contain large amounts of local memory, for example, high-end graphics cards can contain well over 1 GB of DDR2 SDRAM. Many operating systems, such as 32-bit-based operating systems, cannot allocate that much memory resource to a single entity. If the adapter does not implement some sort of aperture windowing scheme, the OS typically ignores the resource request. As a

result, the system is unable to use the adapter. The resizable base address registers (BAR) feature gives the designer some control so that this does not occur. If the system cannot allocate the full amount of resource the adapter is requesting, it can resize the BAR to a smaller, more acceptable aperture, thereby allowing the adapter to still function within the system. The PCI Express solution in the 7 series FPGAs has full support for the Resizable BAR feature.

## Atomic Operations

Atomic Operations introduces three new TLP types that are intended to improve system performance and latency by creating standard synchronization primitives such as mutexes and spin-locks, directly over the I/O bus, in this case, PCI Express. This is helpful in any system with multiple producers and consumers, for example, a multi-CPU system. The target application space for this feature is in co-processing and hardware acceleration adapters. The 7 series FPGAs fully support Atomic Operations.

## Other Advanced Features

In addition to Resizable BARs and Atomic Operations, the 7 series FPGAs support many of the ECNs introduced in the v2.1 and v3.0 of the *PCI Express Base Specification*. Many are supported directly by the block without any user intervention:

- Extended Tag Field Enable
- Internal Error Reporting
- ASPM Optionality

Some ECNs require additional user logic within the FPGA logic to fully implement:

- Alternate Rid Interpretation
- Dynamic Power Allocation
- TLP Processor Hints

## Conclusion

The Integrated Block for PCI Express marks the third generation of integrated PCI Express within a Xilinx FPGA family. Drawing on such broad experience, Xilinx has developed the easiest to use, most feature-rich, and highest performing PCI Express FPGA solution on the market. The optimized architecture and scalable AXI4 interconnect allows users the ability to seamlessly reuse and migrate existing designs across the family from low-cost, ultra low-power designs in Artix-7 FPGAs to high-performance applications with Virtex-7 devices. New features such as PCI Express Gen 3, straddled packets, and SR-IOV will allow designers to achieve bandwidth and system performance never before imagined. With simple software tool flows and Targeted Reference Designs, designers can easily customize the Integrated Block for PCI Express and accelerate time-to-market for their application.

## Additional Information

[WP359](#), *Accelerating System Designs Requiring High-Bandwidth Connectivity with Targeted Reference Designs*

[XTP025](#), *IP Release Notes Guide*

IP Release Notes: <http://www.xilinx.com/technology/protocols/pciexpress.htm>

## Revision History

The following table shows the revision history for this document:

Date	Version	Description of Revisions
03/09/11	1.0	Initial Xilinx release.
09/21/12	1.1	Updated <a href="#">7 Series FPGAs PCI Express Overview</a> and <a href="#">New PCI Express Features for 7 Series FPGAs</a> . Added new section <a href="#">PCI Express Gen 3 Integrated Block for Virtex XT and HT Devices</a> , including a new <a href="#">Figure 1</a> . Updated <a href="#">Additional Information</a> .

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